

Abstract

An object of the present invention is to prevent occurrence of stains on polycrystalline silicon lumps even if the polycrystalline silicon lumps are stored for a long period of time and exposed to a high temperature and high humidity environment during transportation in a packaging body in which a resin bag is filled with the polycrystalline silicon lumps. The polycrystalline silicon lump packaging body according to the present invention is a packaging body in which the resin bag is filled with the polycrystalline silicon lumps having a surface metal concentration of 1000 pptw or less, in which a nitrate ion amount and preferably a fluorine ion amount present inside the packaging body are each 50 $\mu\text{g/L}$ or less with respect to a filling void of the polycrystalline silicon lumps formed when the packaging body is left at 25°C under 1 atm.

[No Figure]